Advanced Power Electronics Corp.

APE8875

1.6X LINEAR REGULATOR FOR DC FAN DRIVER

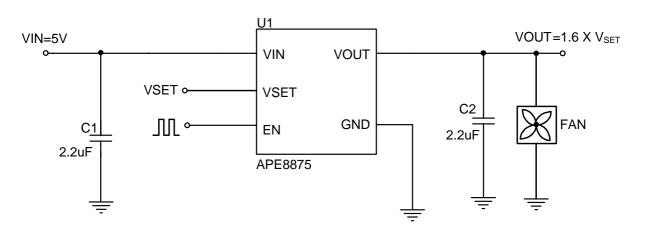
FEATURES

- Low Dropout Voltage: 200mV@0.6A
- VO Follows 1.6 Times of VSET
- Enable/Shutdown Function
- Stable with Low ESR Ceramic Capacitors
- Current-Limit and Thermal Shutdown
 Protection
- TSOT-26 & SO-8 Pb-Free Package
- Halogen Free Product

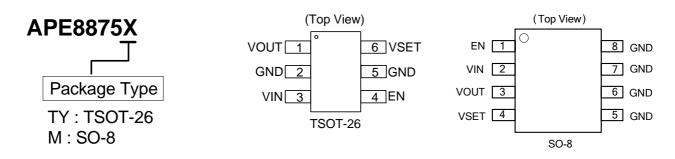
DESCRIPTIOON

The APE8875 is a low dropout linear regulator which is designed to power a DC fan and delivers up to 600mA output current. The output voltage follows the 1.6 times of VSET voltage and typical dropout voltage is only 200mV (typical) at 600mA output current. The VSET voltage can form 0.1V to 3.3V to guarantee VO 1.6 times of VSET. An enable pin further reduces power dissipation while shut-down. The features of current limit (with fold back current) and over temperature protection protect the device against current over-loads and over temperature. The APE8875 is available in a TSOT-26 & SO-8 package.

TYPICAL APPLICATION



ORDERING / PACKAGE INFORMATION



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ABSOLUTE MAXIMUM RATINGS (at T_A=25°C)

VIN Supply Voltage (V _{IN})	-0.3 to 6.5V
EN Voltage (V _{EN})	-0.3 to VIN
VSET Voltage (V _{SET})	-0.3 to VIN
Power Dissipation (P _D)	0.4W
Storage Temperature Range (T _{ST})	-65 to +150°C
Junction Temperature Range (T _J)	-40 to +125°C
Operating Temperature Range (T _{OP})	-40 to +85°C
Thermal Resistance from Junction to $Case(Rth_JC)$	
TSOT-26	50°C/W
SO-8	25°C/W
Thermal Resistance from Junction to Ambient(Rth_{JA})	
TSOT-26	100°C/W
SO-8	70°C/W

Note: Rth_{JA} is measured with the PCB copper area approximately 1.5 ir² (Multi-layer) that connect to GND Pins.

ELECTRICAL SPECIFICATIONS

($V_{SET} = 2V$, $V_{IN} = 5V$, $I_{OUT} = 0.5A$, $C_{IN}=C_{OUT}=2.2uF$, $T_A=25^{\circ}C$ unless otherwise specified)

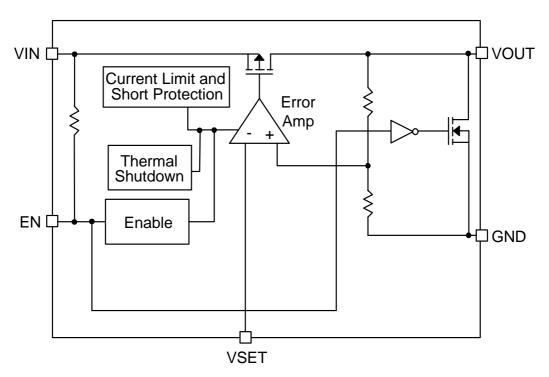
Parameter	SYM	TEST CONDITION	MIN	TYP	MAX	UNITS
VIN Supply Voltage Range	V _{IN}		4.5	-	6	V
Quiescent Current	I _{CCQ}	No Load	-	50	80	uA
Standby Current	I _{STB}	V _{EN} =0V	-	1	10	uA
Output Voltage/V _{SET} Voltage	V _O /V _{SET}	V _{IN} =5.5V, V _{SET} =1V~3.3V	1.552	1.6	1.648	V/V
Line Regulation		V _{IN} =4.5V to 5.5V	-	0.2	0.5	%
Load Regulation		I _{OUT} =10mA ~ 0.6A	-	30	60	mV
Dropout Voltage	V _{Drop}	I _{OUT} =0.6A, V _{SET} =3.3V	-	200	320	mV
Current Limit	I _{Limt}		700	-	-	mA
Short Circuit Current	I _{Short}	Vo<0.6V	-	250	-	mA
VSET Voltage Range	V _{SET}		0.1	-	3.3	V
VSET Pin Current	I _{SET}	V _{SET} =5V	-	80	200	nA
EN Din Logio Throphold Voltage	V _{EN-H}	Operating mode	2	-	-	- V 0.8
EN Pin Logic Threshold Voltage	$V_{\text{EN-L}}$	Shutdown mode	-	-	0.8	
Enable Pin Current	I _{ENH}	V _{EN} =V _{IN}	-	0.003	0.1	μA
	I _{ENL}	V _{IN} =5V, V _{EN} =0V	-	1	5	μA
VOUT Pull Low Resistance	Ro	V _{EN} =0V	-	60	-	Ω
Thermal Shutdown Temp	T _{SD}		-	150	-	°C
Thermal Shutdown Hysteresis			-	30	-	°C



PIN DESCRIPTIONS

PIN SYMBOL	PIN DESCRIPTION	
VIN	IC power supply pin.	
EN	This pin is pulling High inside. If EN input < 0.8V, the IC is into shutdown mode.	
VSET	This pin sets the output voltage. Its voltage can form 0.1V to 3.3V to guarantee	
	VOUT 1.6 times of VSET	
GND	Ground Pin	
VOUT	Output Pin. Its voltage is 1.6 times of VSET	

BLOCK DIAGRAM



FUNCTION DESCRIPTIONS

Output Voltage Regulation

The Output Voltage is set by VSET voltage. VOUT output voltage follows the 1.6 times of VSET voltage until it reaches VIN voltage.

Enable/Shutdown

Driving the EN high turns on the regulator, driving the EN low puts the regulator into shutdown mode. A logic low also causes the output voltage to discharge to the GND. The EN is pulled Hight by an internal resistor.

FUNCTION DESCRIPTIONS

Current-Limit

The APE8875 monitors the current via the output PMOS and limits the maximum current to prevent load and APE8875 from damages during overload or short circuit conditions.

Short Current Protection

When the output voltage drops below 0.6V (typical), which is caused by over load or short circuit, the fold back current limit circuitry limits the output current to 250mA. The fold back current limit is used to reduce the power dissipation during short circuit condition.

Thermal Shutdown

A thermal shutdown circuit limits the junction temperature of APE8875. When the junction temperature exceeds +150°C, a thermal sensor turns off the output PMOS, allowing the device to cool down. The regulator regulates the output again through initiation of a new soft-start cycle after the junction temperature cools by 30°C, resulting in a pulsed output during continuous thermal overload conditions.

APPLICATION INFORMATION

Capacitor Selection

Normally, use a 2.2μ F capacitor on the input and a 2.2μ F capacitor on the output of the APE8875. In order to insure the circuit stability, the proper output capacitor value should be larger than 1uF. With X5R and X7R dielectrics, 2.2uF is sufficient at all operating temperatures.

Thermal Considerations

The APE8875 series can deliver a current of up to 600mA over the full operating junction temperature range. However, the maximum output current must be dated at higher ambient temperature to ensure the junction temperature does not exceed 125° C. With all possible conditions, the junction temperature must be within the range specified under operating conditions. Power dissipation can be calculated based on the output current and the voltage drop across regulator.

$$\mathsf{P}_{\mathsf{D}} = (\mathsf{V}_{\mathsf{IN}} - \mathsf{V}_{\mathsf{OUT}}) \mathsf{I}_{\mathsf{O}}$$

The final operating junction temperature for any set of conditions can be estimated by the following thermal equation:

$$P_{D (MAX)} = (T_{J (MAX)} - T_A) / Rth_{JA}$$

Where $T_{J(MAX)}$ is the maximum junction temperature of the die (125°C) and T_A is the maximum ambient temperature. The junction to ambient thermal resistance (Rth_{JA}) for TSOT-26 package at recommended minimum footprint is 100°C/W.

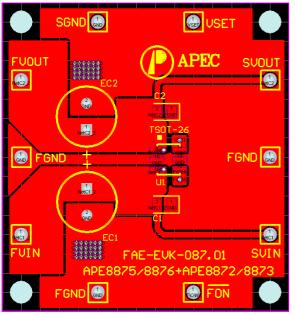


FUNCTION DESCRIPTIONS

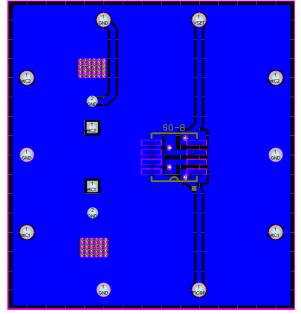
PCB Layout

- 1. Please place the input capacitors close to the VIN
- 2. Ceramic capacitors for load must be placed near the load as close as possible
- 3. To place APE8875 and output capacitors near the load is good for performance.
- 4. Large current paths that VIN and Output lines must have wide tracks.
- 5. GND connect large copper area can reduced IC temperature.

PCB Layout Guide



(Top View)

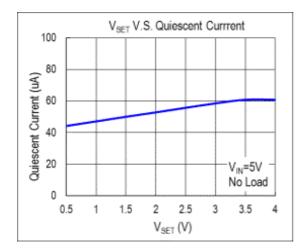


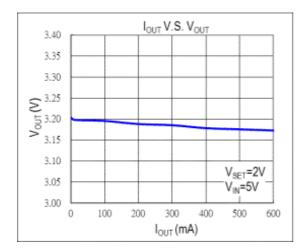
(Bottom View)

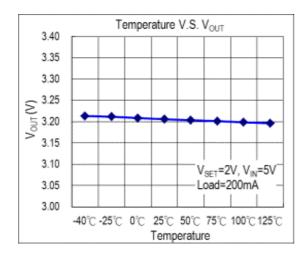


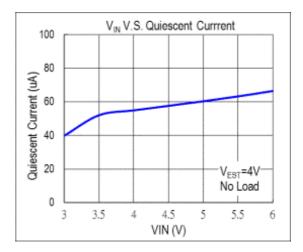
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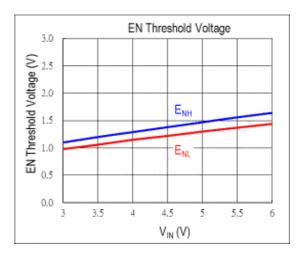
TYPICAL PERFORMANCE CHARACTERISTICS

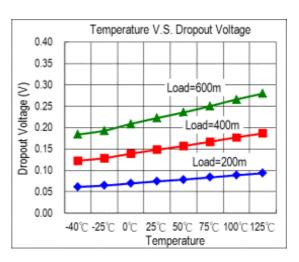








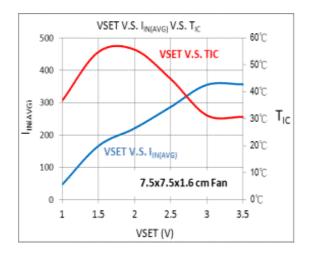


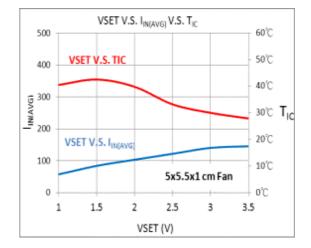


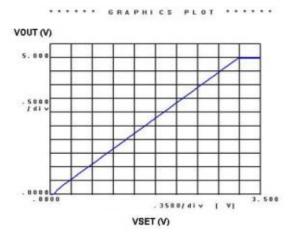


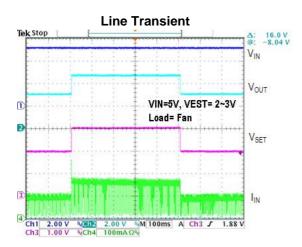
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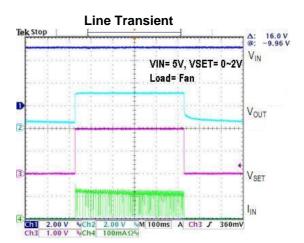
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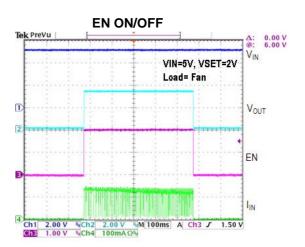








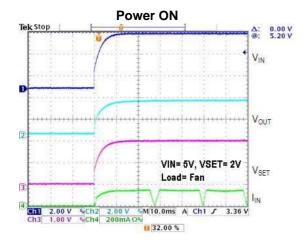




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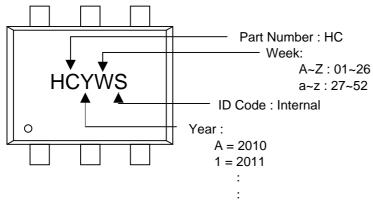
Electronics Corp. TYPICAL PERFORMANCE CHARACTERISTICS



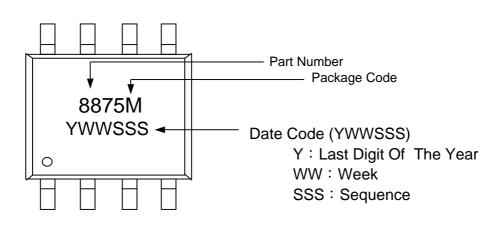


MARKING INFORMATION

TSOT-26



SO-8



APE8875